



NOTES:

- 1) R8 for test purposes only

ASSEMBLY:

- 1) built on PCB PMP2644RevB
- 2) R2, R100, C5, C6 OPEN
- 3) D2, L1, L2 does NOT meet pattern
- 4) C1 bottom side assy

Revision History

Revision	Notes
A	*** preliminary ***
B	*** adjusted Fsw

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Number: PMP30370 | Rev: B
 SVN Rev: Version control disabled
 Drawn By:
 Engineer: B.Geck

Designed for: Public Release | Mod. Date: 10/23/2017
 Project Title: tiny auxiliary telecom buck w/ input filter
 Sheet Title:
 Assembly Variant: [No Variations] | Sheet: 1 of 1
 File: PMP30370RevB.SchDoc | Size: A4
 Contact: <http://www.ti.com/support>



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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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